



# Cree® XLamp® XP-G LEDs



#### **PRODUCT DESCRIPTION**

The XLamp XP-G LED delivers unprecedented levels of light output and efficacy for a single die LED. The XLamp XP-G LED continues Cree's history of innovation in LEDs for lighting applications with wide viewing angle, symmetrical package, unlimited floor life and electrically neutral thermal path.

XLamp XP-G LEDs are the ideal choice for lighting applications where high light output and maximum efficacy are required, such as LED light bulbs, outdoor lighting, portable lighting, indoor lighting and solar-powered lighting.

#### **FEATURES**

- Available in white, outdoor white and 80-CRI, 85-CRI and 90-CRI white
- ANSI-compatible chromaticity bins
- Maximum drive current: 1500 mA
- Low thermal resistance: 6°C/W
- Wide viewing angle: 125°
- Unlimited floor life at ≤ 30°C/85% RH
- Reflow solderable JEDEC J-STD-020C
- Electrically neutral thermal path
- · RoHS and REACH-compliant
- UL-recognized component (E326295)

# **TABLE OF CONTENTS**

Flux Characteristics2
Characteristics3
Relative Spectral Power
Distribution4
Relative Flux vs. Junction Tempera-
ture4
Electrical Characteristics5
Thermal Design5
Relative Flux vs. Current6
Typical Spatial Distribution6
Reflow Soldering Characteristics 7
Notes8
Mechanical Dimensions9
Tape and Reel10
Packaging 11



# FLUX CHARACTERISTICS $(T_1 = 25^{\circ}C)$

The following table provides several base order codes for XLamp XP-G LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family.

Color	сст ғ	Range	Base Order Codes Min Luminous Flux @ 350 mA (lm)		Order Code	
	Min.	Max. Group Flux (		Flux (lm)		
	Cool White 5,000 K	8,300 K	R2	114	XPGWHT-L1-0000-00E51	
6 1 1 1 1 1			R3	122	XPGWHT-L1-0000-00F51	
Cool White			R4	130	XPGWHT-L1-0000-00G51	
			R5	139	XPGWHT-L1-0000-00H51	
			R2	114	XPGWHT-01-0000-00EC2	
Outdoor White	4,000 K	5,300 K	R3	122	XPGWHT-01-0000-00FC2	
			R4	130	XPGWHT-01-0000-00GC2	
	3,700 K	5,000 K	Q5	107	XPGWHT-L1-0000-00DE4	
Neutral White			R2	114	XPGWHT-L1-0000-00EE4	
			R3	122	XPGWHT-L1-0000-00FE4	
	2,600 K 4,3		Q3	93.9	XPGWHT-H1-0000-00BE7	
80-CRI White		4,300 K	Q4	100	XPGWHT-H1-0000-00CE7	
			Q5	107	XPGWHT-H1-0000-00DE7	
			Q3	93.9	XPGWHT-L1-0000-00BE7	
Warm White	2,600 K	3,700 K	Q4	100	XPGWHT-L1-0000-00CE7	
			Q5	107	XPGWHT-L1-0000-00DE7	
	2,600 K	3,200 K	P4	80.6	XPGWHT-P1-0000-009E7	
85-CRI White			Q2	87.4	XPGWHT-P1-0000-00AE7	
			Q3	93.9	XPGWHT-P1-0000-00BE7	
OO CDI White	2 600 16	2 200 14	P4	80.6	XPGWHT-U1-0000-009E7	
90-CRI White	2,600 K	3,200 K	Q2	87.4	XPGWHT-U1-0000-00AE7	

#### Notes:

- Cree maintains a tolerance of  $\pm 7\%$  on flux and power measurements and  $\pm 2$  on CRI measurements.
- Typical CRI for Cool White and Neutral White (3,700 K 10,000 K CCT) is 75.
- Typical CRI for Outdoor White (4,000 K 5,300 K CCT) is 70.
- Typical CRI for Warm White (2,600 K 3,700 K CCT) is 80.
- Minimum CRI for 80-CRI White is 80.
- Minimum CRI for 85-CRI White is 85.
- Minimum CRI for 90-CRI White is 90.



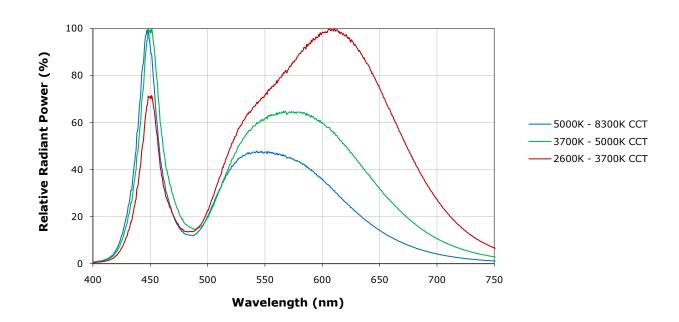
# **CHARACTERISTICS**

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		6	
Viewing angle (FWHM)	degrees		125	
Temperature coefficient of voltage	mV/°C		-2.1	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current	mA			1500
Reverse voltage	V			5
Forward voltage (@ 350 mA)	V		3.0	3.75
Forward voltage (@ 700 mA)	V		3.2	
Forward voltage (@ 1000 mA)	V		3.3	
LED junction temperature	°C			150

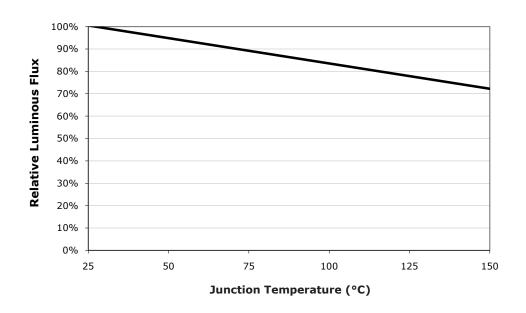
<sup>\*</sup> The increase of maximum forward current to 1500 mA for XLamp XP-G Cool White is retroactive and applies to all XLamp XP-G Cool White LEDs produced by Cree. The increase is the result of more extensive qualification testing that was performed after the initial product launch.



# **RELATIVE SPECTRAL POWER DISTRIBUTION**

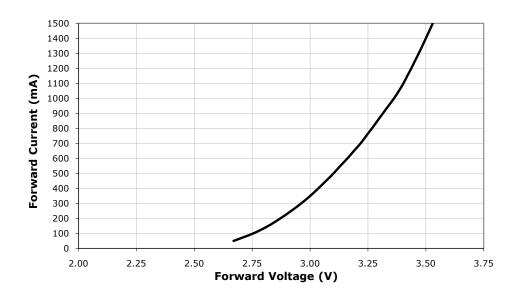


# RELATIVE FLUX VS. JUNCTION TEMPERATURE ( $I_F = 350 \text{ MA}$ )



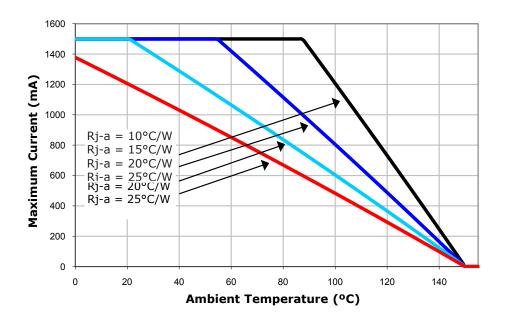


# **ELECTRICAL CHARACTERISTICS (T<sub>1</sub> = 25°C)**



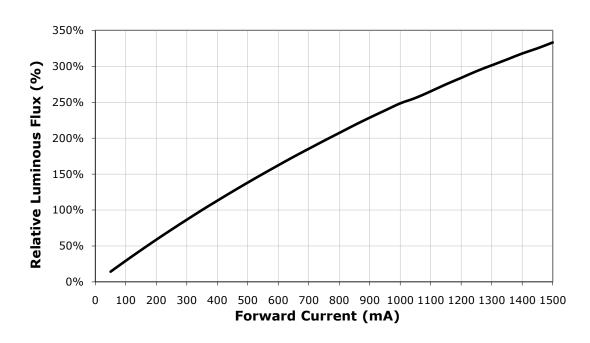
#### THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.

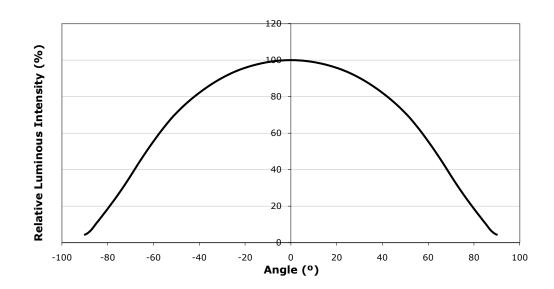




# RELATIVE FLUX VS. CURRENT $(T_1 = 25^{\circ}C)$



# TYPICAL SPATIAL DISTRIBUTION

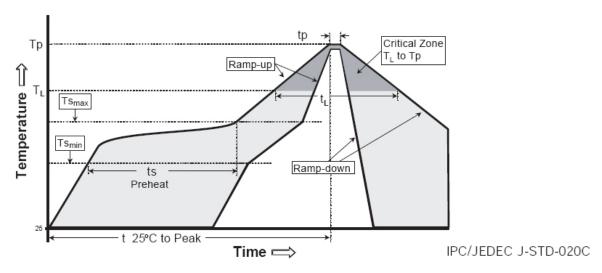




#### **REFLOW SOLDERING CHARACTERISTICS**

In testing, Cree has found XLamp XP-G LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (Ts <sub>max</sub> to Tp)	3°C/second max.	3°C/second max.
Preheat: Temperature Min (Ts <sub>min</sub> )	100°C	150°C
Preheat: Temperature Max (Ts <sub>max</sub> )	150°C	200°C
Preheat: Time (ts <sub>min</sub> to ts <sub>max</sub> )	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T <sub>L</sub> )	183°C	217°C
Time Maintained Above: Time $(t_L)$	60-150 seconds	60-150 seconds
Peak/Classification Temperature (Tp)	215°C	260°C
Time Within 5°C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6°C/second max.	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



#### **NOTES**

# **Lumen Maintenance Projections**

Cree currently recommends a maximum drive current of 1000 mA for XLamp XP-G white in designs seeking the ENERGY STAR\* 35,000 hour lifetime rating ( $\geq$  94.1% luminous flux @ 6000 hours) or 25,000-hour lifetime rating ( $\geq$  91.8% luminous flux @ 6000 hours).

Please read the XLamp Long-Term Lumen Maintenance application note for more details on Cree's lumen maintenance testing and forecasting. Please read the XLamp Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

\* These lifetime ratings are based on the current ENERGY STAR Solid State Lighting Luminaires V1.1 (December 12, 2008) and ENERGY STAR Integral LED Lamps V1.0 (December 3, 2009) lumen maintenance criteria.

# **Moisture Sensitivity**

In testing, Cree has found XLamp XP-G LEDs to have unlimited floor life in conditions ≤30°C / 85% relative humidity (RH). Moisture testing included a 168 hour soak at 85°C / 85% RH followed by 3 reflow cycles, with visual and electrical inspections at each stage.

#### **RoHS Compliance**

The levels of environmentally sensitive, persistent biologically toxic (PBT), persistent organic pollutants (POP), or otherwise restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2002/95/EC on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS), as amended through April 21, 2006.

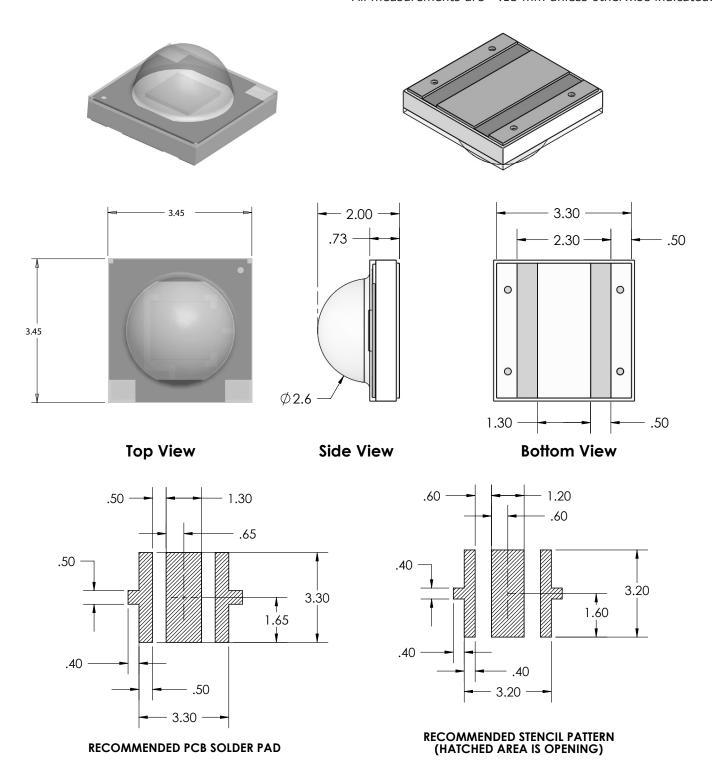
#### **Vision Advisory Claim**

WARNING: Do not look at exposed lamp in operation. Eye injury can result. See LED Eye Safety at http://www.cree.com/products/pdf/XLamp\_EyeSafety.pdf.



# MECHANICAL DIMENSIONS $(T_A = 25^{\circ}C)$

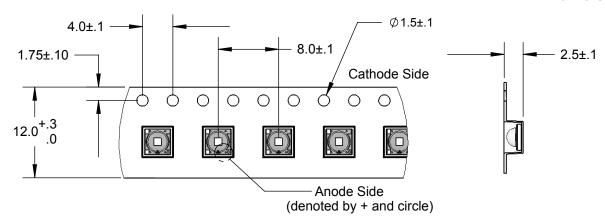
All measurements are  $\pm .13$  mm unless otherwise indicated.

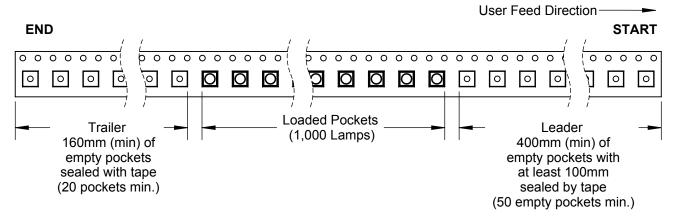


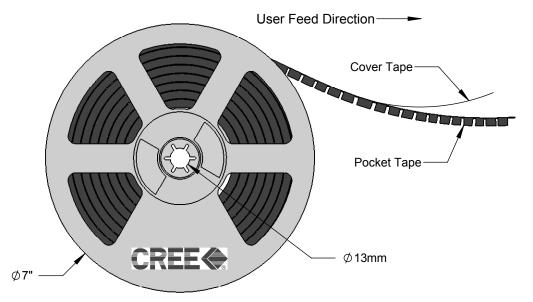


#### **TAPE AND REEL**

All dimensions in mm.









# **PACKAGING**

All dimensions in mm.

